



2026 杭州国际 AI算力与数据中心产业博览会

Hangzhou International AI Computing Power and Data Center Industry Expo 2026

同期举办：杭州数据中心液冷产业大会暨展览会

Hangzhou Data Center Liquid Cooling Industry Conference & Exhibition 2026

智算引领未来 · 算力赋能百业

Intelligent Computing Leading the Future · Computing Power Empowering Industries

2026.11.11-13

杭州大会展中心-浙江

Hangzhou Grand Convention and Exhibition Center-Zhejiang

主办单位 | Hosted By

浙江省计算机系统集成行业协会

Zhejiang Computer Information System Integration Industry Association

高登会展集团

Golden Conference&Exhibition Group Co., Ltd.

承办单位 | Organized By

上海大道国服展览有限公司

Shanghai Top Sequoia Exhibition Co., Ltd.

Q www.liquidcoolingexpo.com

展会概况 | Exhibition Overview

人工智能浪潮席卷全球，算力成为驱动数字经济的核心引擎！为抢抓AI大模型爆发与智算产业升级的战略机遇，“2026杭州国际AI算力产业大会暨展览会”将于2026年11月11日-13日在杭州大会展中心盛大举办。本届展会依托杭州“全国数字经济第一城”与国家人工智能创新发展试验区优势，打造全球AI算力全产业链展示、交流、合作、采购的顶级平台，诚邀您共襄盛举，共探算力新趋势、共拓产业新蓝海。本届博览会以“高算力、大模型、新生态、深应用”为核心方向，全面契合AI算力需求指数级增长、智算中心规模化建设、绿色低碳发展的产业趋势。展会规划总展出面积30000平方米，预计汇聚500+家全球顶尖算力企业参展，吸引20000人次专业观众到场参观。展会覆盖AI算力从底层硬件、核心技术到上层应用、配套服务的全产业链条，聚焦智算芯片、AI服务器、智算中心、液冷散热、大模型训练、算力网络、行业解决方案等热点领域。通过前沿技术展示、高端论坛研讨、精准供需对接、新品首发推介，搭建政企研、产供销协同生态，助力企业把握万亿级算力市场机遇，推动AI算力技术成果转化与产业落地。

As the wave of artificial intelligence sweeps across the globe, computing power has become the core engine driving the digital economy. To seize the strategic opportunities presented by the explosion of large AI models and the upgrade of the intelligent computing industry, the "2026 Hangzhou International AI Computing Power Industry Conference & Exhibition" will be grandly held at the Hangzhou Grand Convention and Exhibition Center from November 11 to 13, 2026. Leveraging Hangzhou's advantages as the "No. 1 Digital Economy City in China" and a National AI Innovation and Development Pilot Zone, this event aims to create a premier global platform for showcasing, exchanging, collaborating, and procuring across the entire AI computing power industry chain. We sincerely invite you to join this grand event to explore new trends in computing power and tap into new blue ocean markets. With the core focus on "High-Performance Computing, Large Models, New Ecosystems, and Deep Applications," this expo aligns comprehensively with the industry trends of exponential growth in AI computing demand, large-scale construction of intelligent computing centers, and green, low-carbon development. The exhibition is planned to cover a total area of 30,000 square meters, expecting to gather 500+ of the world's top computing power enterprises and attract 20,000+ professional visitors. The expo covers the entire industrial chain of AI computing power, from underlying hardware and core technologies to upper-layer applications and supporting services, focusing on hot topics such as intelligent computing chips, AI servers, intelligent computing centers, liquid cooling, large model training, computing power networks, and industry-specific solutions. Through cutting-edge technology showcases, high-end forums, precise supply-demand matchmaking, and new product launch promotions, the event aims to build a collaborative ecosystem connecting government, enterprises, research institutions, production, supply, and sales. It will assist companies in seizing trillion-level market opportunities in computing power and accelerate the transformation and industrial implementation of AI computing technology achievements.

同期活动 | Concurrent Events



展会同期举办多场高规格专业论坛与产业活动，汇聚全球顶尖科学家、行业领袖、技术专家，共话算力未来

A series of high-level professional forums and industrial activities will be held concurrently, bringing together top global scientists, industry leaders, and technical experts to discuss the future of computing power:

杭州 AI 算力产业发展高峰论坛

Hangzhou AI Computing Power Industry Development Summit Forum

解读全球算力政策导向、市场趋势、技术突破与产业格局，探讨智算产业高质量发展路径。

Interpreting global computing power policy directions, market trends, technological breakthroughs, and industrial landscapes; exploring pathways for high-quality development of the intelligent computing industry.

AI 大模型与智算中心建设峰会

AI Large Models and Intelligent Computing Center Construction Summit

聚焦大模型训练算力需求、智算中心规划设计、高效算力调度、国产算力生态构建等核心议题。

Focusing on core topics such as computing power requirements for large model training, planning and design of intelligent computing centers, efficient computing power scheduling, and the construction of domestic computing ecosystems.

绿色算力与液冷散热技术大会

Green Computing and Liquid Cooling Technology Conference

围绕高密算力散热、液冷技术规模化应用、低 PUE 智算中心、可再生能源融合、碳达峰碳中和实践。

Centered on high-density computing heat dissipation, large-scale application of liquid cooling technology, low PUE intelligent computing centers, integration of renewable energy, and carbon peak-ing/carbon neutrality practices.

算力网络与算网融合发展论坛

Computing Power Network and Computing-Network Integration Development Forum

探讨算力网络架构、800G/1.6T 光通信、边缘算力、分布式算力、算力调度与数据传输技术。

Discussing computing power network architecture, 800G/1.6T optical communications, edge computing power, distributed computing power, and computing scheduling/data transmission technologies.

AI 算力行业应用对接会

AI Computing Power Industry Application Matchmaking Meeting

面向智能制造、智慧医疗、金融科技、自动驾驶、数字政府等领域，组织算力供需精准对接。

Organizing precise supply-demand matchmaking for computing power in fields such as intelligent manufacturing, smart healthcare, fintech, autonomous driving, and digital government.

新品发布会与技术创新路演

New Product Launches and Technology Innovation Roadshows

支持企业举办 AI 芯片、服务器、智算方案、大模型等新品首发、技术路演与合作签约。

Supporting enterprises in hosting debuts of new AI chips, servers, intelligent computing solutions, and large models, as well as technology roadshows and partnership signings.

算力产业人才交流大会

Computing Power Industry Talent Exchange Conference

搭建校企、企企人才对接平台，招揽算力架构师、芯片研发、智算运维等高端技术人才。

Building a talent matchmaking platform connecting universities with enterprises and facilitating business-to-business hiring to recruit high-end technical talents in computing architecture, chip R&D, and intelligent computing operations.



AI 算力核心硬件

AI Computing Core Hardware

AI 芯片: GPU、ASIC、FPGA、NPU、DPU、CPU 等智算芯片、训练芯片、推理芯片

AI 服务器: 高密度 AI 服务器、GPU 服务器、液冷服务器、智算集群、超算服务器

存储设备: 高速分布式存储、NVMe 存储、AI 专用存储、数据备份与灾备系统

网络设备: 800G/1.6T 光模块、高速交换机、路由器、SDN/NFV、算力网络设备

AI Chips: GPU, ASIC, FPGA, NPU, DPU, CPU and other intelligent computing chips, training chips, inference chips.

AI Servers: High-density AI servers, GPU servers, liquid-cooled servers, intelligent computing clusters, supercomputing servers.

Storage Devices: High-speed distributed storage, NVMe storage, AI-specific storage, data backup and disaster recovery systems.

Network Equipment: 800G/1.6T optical modules, high-speed switches, routers, SDN/NFV, computing power network equipment.

智算中心与基础设施

Intelligent Computing Centers & Infrastructure

智算中心整体解决方案、模块化智算中心、边缘智算节点、超算中心

液冷系统（冷板、浸没、喷淋）、间接蒸发冷却、高效空调、智能散热方案

精密配电、UPS、储能系统、光伏、微电网、智能母线、消防与安防系统

Comprehensive solutions for intelligent computing centers, modular intelligent computing centers, edge intelligent computing nodes, supercomputing centers.

Liquid cooling systems (cold plate, immersion, spray), indirect evaporative cooling, high-efficiency HVAC, intelligent thermal management solutions.

Precision power distribution, UPS, energy storage systems, photovoltaics, microgrids, intelligent busways, fire protection and security systems.

大模型与算力软件

Large Models & Computing Software

通用大模型、行业大模型、多模态模型、模型训练与微调平台

算力管理平台、DCIM 系统、智能运维、AI 辅助运维、算力调度与优化软件

操作系统、数据库、AI 开发框架、算法模型、虚拟化与云计算软件

General-purpose large models, industry-specific large models, multimodal models, model training and fine-tuning platforms.

Computing power management platforms, DCIM systems, intelligent O&M, AI-assisted O&M, computing scheduling and optimization software.

Operating systems, databases, AI development frameworks, algorithm models, virtualization and cloud computing software.

算力网络与安全

Computing Power Network & Security

算网融合、边缘计算、5G/6G 算力网络、高速数据传输、云网边端协同

数据安全、网络安全、算力安全、隐私计算、加密与防护、灾备与业务连续性

Computing-network convergence, edge computing, 5G/6G computing power networks, high-speed data transmission, cloud-network-edge-device collaboration.

Data security, network security, computing power security, privacy computing, encryption and protection, disaster recovery and business continuity.

行业算力应用方案

Industry Computing Application Solutions

智能制造、智慧医疗、金融科技、自动驾驶、智慧城市、数字政府算力方案

AIGC、内容生成、智能视觉、自然语言处理、具身智能、机器人算力支撑

Computing power solutions for intelligent manufacturing, smart healthcare, fintech, autonomous driving, smart cities, and digital government.

AIGC, content generation, intelligent vision, natural language processing, embodied intelligence, robotic computing power support.

配套服务与生态

Supporting Services & Ecosystem

智算中心 EPC、规划设计、测试评估、运维托管、技术咨询

算力租赁、云计算服务、公有云 / 私有云 / 混合云、算力交易平台

科研院所、行业协会、投资机构、产业园区、人才培养与认证

Intelligent Computing Center EPC, planning and design, testing and evaluation, O&M outsourcing, technical consulting.

Computing power leasing, cloud computing services, public/private/hybrid cloud, computing power trading platforms.

Research institutes, industry associations, investment institutions, industrial parks, talent cultivation and certification.

展会费用 | Participation Fees

★ 标准展位:

A: 国内企业: 标准展位16800.00/展期 (RMB) 3m×3m

B: 国外企业: 标准展位4800.00/展期 (USD) 3m×3m

展位包括: 三面白色壁板、中(英)文楣牌制作、咨询桌一张、折椅二把、地毯满铺、展位照明、220V/5A电源插座一个、废纸篓一个。)

★ 室内光地:

A: 国内企业: 1600 (RMB) /平方米

B: 国外企业: 480 (USD) /平方米

注: (最少36平方米起租) “光地”只提供参展面积, 不包括展架、展具、地毯、电源等。

International Standard Booths:

For overseas enterprises: USD 4800.00/Expo; 3m×3m

Each standard booth consists of 3-sided white wallboards, Chinese& English fascia board, 1 consultation desk, 2 folding chairs, fully-floored carpet, booth lighting system, 1 power socket 220V/5A, and a waste basket.

Indoor Raw Space:

For overseas enterprises: USD 480.00/Sq.m.

Note: The raw space (minimum 36 sq.m.) only supplies a show space excluding stand frames, show equipment, carpet and power supply, etc.



目标观众 | Target Audience

电信与云服务行业 | Telecom & Cloud Service Industry

电信运营商（移动/联通/电信）、IDC运营商、云服务商、互联网巨头
Telecom & Cloud Service Industry: Telecom operators (Mobile/Unicom/Telecom), IDC operators, cloud service providers, internet giants.

AI 与科技企业 | AI & Technology Enterprises

AI 大模型公司、芯片企业、服务器厂商、智算解决方案商、算法企业
AI large model companies, chip manufacturers, server vendors, intelligent computing solution providers, algorithm enterprises.

金融与政企领域 | Finance & Government Sectors

银行、证券、保险等金融机构，政府部门、央国企、事业单位信息化部门
Financial institutions (banks, securities, insurance), government departments, central and state-owned enterprises, public institution IT departments.

制造与实体行业 | Manufacturing & Physical Industries

智能制造、汽车、医疗、教育、交通、能源、物流等行业数字化负责人
Digitalization leaders in intelligent manufacturing, automotive, healthcare, education, transportation, energy, and logistics.

工程与科研领域 | Engineering & Scientific Research

智算中心设计院、EPC总包商、系统集成商、高校、科研院所
Intelligent computing center design institutes, EPC general contractors, system integrators, universities, research institutes.

投资与产业领域 | Investment & Industry Sectors

投资机构、产业基金、产业园区、行业协会、渠道代理商
Investment institutions, industrial funds, industrial parks, industry associations, channel agents/distributors.

立即注册 | Booth Registration

如欲订“2026杭州国际AI算力与数据中心产业博览会”展位，或了解更多信息，请立即发电子邮件至info@goldenexpo.com.cn。或通过以下联络方法，预订展位。

To book a booth at the AICE 2026 or for more information, please email us immediately at info@goldenexpo.com.cn. or use the contact details below to reserve your space.

电话/Tel: 021-64396190 Email: info@goldenexpo.com.cn